



IDA-07318

MagIC™ Silicon Bipolar MMIC

1.5 Gb/s Laser Diode Driver

Features

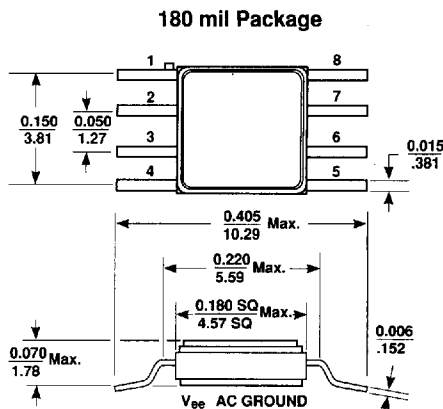
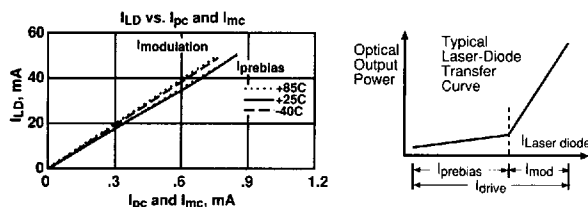
- **High Data Rates: 1.5 Gb/s NRZ**
- **High Modulation Current: 50 mA**
- **High Prebias Current: 50 mA**
- **Low VSWR 50 Ω Input, ECL Level Compatible**
- **Differential or Single-ended Inputs**
- **Separate Modulation and Prebias Controls**
- **Single Power Supply: +5 V or -5.2 V**
- **Hermetic Glass-metal Surface Mount Package**

Description

The IDA-07318 is a wideband silicon bipolar Monolithic Microwave Integrated Circuit (MMIC), Laser Diode (LD) driver, housed in a miniature glass-metal hermetic surface mount package. It is designed to provide high speed current drive for laser diodes or light emitting diodes (LEDs). On-chip termination resistors and flexible prebias and modulation control inputs simplify your design.

Typical applications include fiber optic data communications (e.g., FDDI, serial HIPPI) and telecommunications (e.g., SONET) systems where high speed laser diodes are used with data rates up to 1.5 Gb/s. In addition, instrumentation and communication circuits can use the high speed current modulation feature of the DA-07138.

The IDA series of laser diode drivers is fabricated using HP's 10 GHz f_T , 25 GHz f_{MAX} ISOSATM-1 silicon bipolar process that uses nitride self-alignment, submicrometer lithography, trench isolation, ion implantation, gold metallization, and polyimide inter-metal dielectric and scratch protection to achieve excellent performance uniformity, and reliability.



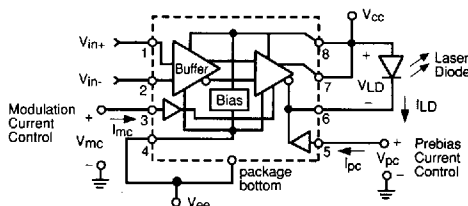
PIN DESCRIPTION	
1 Vin+	8 Vcc
2 Vin-	7 Output Current-
3 Mod, Input	6 Output Current+ (to LED)
4 Vee	5 Prebias Input

Bottom of Package is Vee

Notes:
(unless otherwise specified)

1. Dimensions are in $\frac{\text{in}}{\text{mm}}$
2. Tolerances
in .xxx = $\pm .005$
mm .xx = $\pm .13$

Functional Block Diagram



Guaranteed Electrical Specifications, $T_A = 25^\circ\text{C}$, $V_{CC} = 0\text{ V}$, $V_{EE} = -5.2\text{ V}$, $Z_{\text{Load}} = 12\ \Omega$ (see Test Configuration)

Symbol	Parameters and Test Conditions	Units	Min.	Typ.	Max.
t_r	Output Rise Time, 20% to 80% (Pin 6) $I_{mod} = 25 \text{ mA}, I_{pb} = 50 \text{ mA}$	ps		220	300
t_f	Output Fall Time, 20% to 80% (Pin 6) $I_{mod} = 25 \text{ mA}, I_{pb} = 50 \text{ mA}$	ps		240	320
I_{pb}	Laser Diode Prebias Current Set Range	mA	0-50		
I_{mod}	Laser Diode Modulation Current Set Range ¹	mA	5-50		
I_d	Device Current $V_{cc} - V_{cc} = 5 \text{ V}, I_{mod} = 0 \text{ mA}, I_{pb} = 0 \text{ mA}$		30	40	50

Notes: 1. Recommended operating range for Modulation Current Set is 10 to 50 mA

Design Information, $T_A = 25^\circ\text{C}$, $V_{CC} = 0\text{ V}$, $V_{EE} = -5.2\text{ V}$, $Z_{\text{Load}} = 12\ \Omega$ (see Test Configuration)

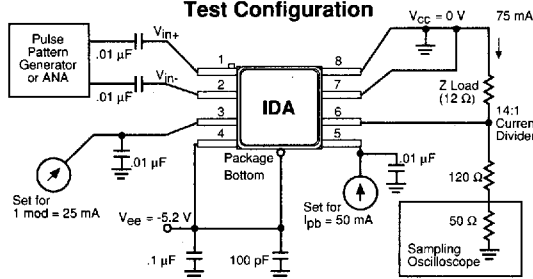
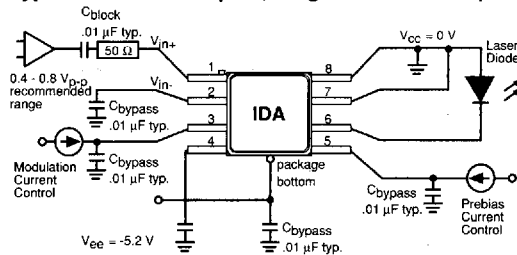
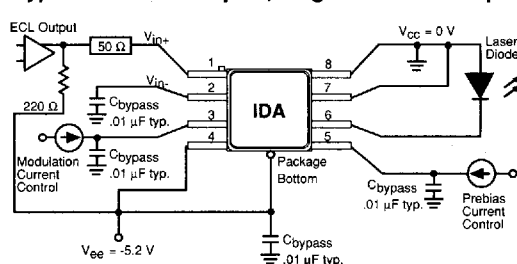
Symbol	Parameters and Test Conditions	Units	Typ.
τ_p	Propagation Delay Time, Input to Output $I_{mod} = 25 \text{ mA}$	ps	300
BW	Small Signal -3 dB Bandwidth $I_{mod} = 25 \text{ mA}$	GHz	2.0
VSWR	V_{in+} , V_{in-} VSWR $f = 0.1$ to 2 GHz		1:1
t_{rpb} , t_{rmod}	Modulation or Prebias Current Output Rise Time (Inputs Pin 3 or 5)	ns	6

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Absolute Maximum Ratings

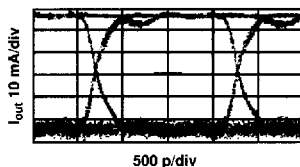
Parameter	Absolute Maximum ¹
Device Voltage	10 V
Power Dissipation ^{2,3}	2.5 W
I_{mod} or I_{pb}	150 mA rms
Junction Temperature	200°C
Storage Temperature	-65 to 200°C

 Thermal Resistance²: $\theta_{jc} = 50^\circ\text{C/W}$
Notes:

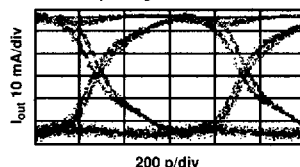
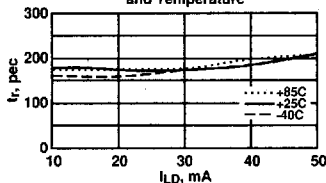
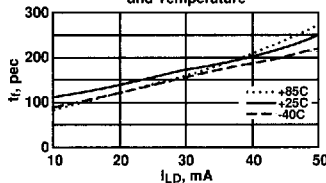
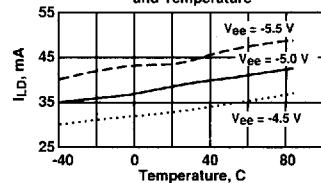
1. Permanent damage may occur if any of these limits are exceeded.
2. $T_{case} = 25^\circ\text{C}$
3. Derate at 20 mW/°C for $T_C > 75^\circ\text{C}$

Test Configuration

Typical Use: AC Coupled, Single-ended 50Ω Input

Typical Use: DC Coupled, Single-ended ECL Input

Typical Performance, $T_A = 25^\circ\text{C}$
 $V_{cc} = 0\text{ V}$, $V_{ee} = 5.2\text{ V}$, $R_L = 12\ \Omega$
 (unless otherwise noted)

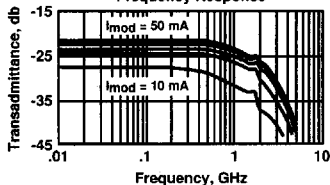
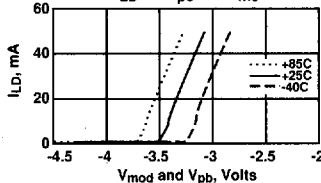
Eye Diagram, 622 Mb/s



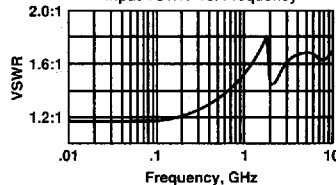
Eye Diagram, 1.5 Gb/s


 Rise Time vs. I_{LD} and Temperature

 Fall Time vs. I_{LD} and Temperature

 I_{device} vs. Power Supply and Temperature


Frequency Response


 I_{LD} vs. V_{pc} and V_{mc}


Input VSWR vs. Frequency



T-90-20

MOTION SENSING
AND CONTROL

Motion Control ICS – HCTL-XXXX Series

Package Outline Drawing	Part No.	Package	Description	Page No.
	HCTL-1100	PDIP	CMOS General Purpose Motion Control IC	1-104
	HCTL-1100 OPT PLC	PLCC	CMOS General Purpose Motion Control IC	
	HCTL-2000	PDIP	CMOS Quadrature Decoder/Counter IC, 12-bit Counter	1-86
	HCTL-2016	PDIP	CMOS Quadrature Decoder/Counter IC, 16-bit Counter	
	New HCTL-2016 OPT PLC	PLCC	CMOS Quadrature Decoder/Counter IC, 16-bit Counter	1-102
	HCTL-2020	PDIP	CMOS Quadrature Decoder/Counter IC, 16-bit Counter, Quadrature Decoder Output Signals, Cascade Output Signals	1-86
	New HCTL-2020 OPT PLC	PLCC	CMOS Quadrature Decoder/Counter IC, 16-bit Counter, Quadrature Decoder Output Signals, Cascade Output Signals	1-102

Accessories for Encoders and Encoder Modules

Package Outline Drawing	Part No.	Description	Page No.
	HEDS-8902	4-wire connector with 15.5 cm (6.1 in.) flying leads. Locks into HEDS-5500 and HEDS-5600 2 channel encoders. Also fits HEDS-9000, HEDS-9100, and HEDS-9200 2 channel encoder modules.	1-61 1-22 1-28
	HEDS-8903	5-wire connector with 15.5 cm (6.1 in.) flying leads. Locks into HEDS-5540 and HEDS-5640 three channel encoders. Also fits HEDS-9040 and HEDS-9140 three channel encoder modules.	1-61 1-32
	HEDS-8905	Alignment Tool for HEDS-9140	1-32
	HEDS-8906	Alignment Tool for HEDS-9040	1-32
	HEDS-8901	Gap Setting shown for film codewheels	1-51
	HEDS-8932	Gap Setting shown for glass codewheels	1-51
	HEDS-8910 OPT 0 □□	Alignment Tool for HEDS-5540/5545 and HEDS-5640/5645. Order in appropriate shaft size.	1-61